



Product Summary

BV _{DSS}	R _{DS(ON)} max	I _D max T _A = 25°C
(00)(3.0Ω @ V _{GS} = 10V	0.6A
100V	4.5Ω @ V _{GS} = 5.0V	0.5A

Description

This new generation MOSFET is designed to minimize the on-state resistance ($R_{DS(ON)}$) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- DC-DC Converters
- Power Management Functions

100V N-CHANNEL ENHANCEMENT MODE MOSFET

Features and Benefits

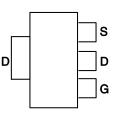
- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

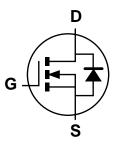
- Case: SOT223
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals Connections: See Diagram Below
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.112 grams (Approximate)



Top View



Pin Out - Top View



Equivalent Circuit

Ordering Information (Note 4)

Part Number	Compliance	Case	Packaging
ZVNL110GTA	Standard	SOT223	1,000/Tape & Reel

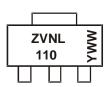
Notes: 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.

2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



SOT223

 $\begin{array}{l} {\sf ZVNL110} = {\sf Product Type Marking Code} \\ {\sf YWW} = {\sf Date Code Marking} \\ {\sf Y or } \overline{{\sf Y}} = {\sf Last Digit of Year (ex: 5= 2015)} \\ {\sf WW or } \overline{{\sf WW}} = {\sf Week Code (01{\sim}53)} \\ \end{array}$



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units		
Drain-Source Voltage			V _{DSS}	100	V
Gate-Source Voltage			V _{GSS}	±20	V
Continuous Drain Current (Note 6) $V_{GS} = 10V$ Steady $T_A = +25^{\circ}C$ State $T_A = +70^{\circ}C$			Ι _D	0.6 0.5	А
Pulsed Drain Current (10µs Pulse, Duty Cycle ≦ 1%)	I _{DM}	6	А		
Maximum Body Diode Continuous Current (Note 6)			ls	1.5	A

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units		
Total Dower Dissinction	(Note 5)	D	1.1	W	
Total Power Dissipation	(Note 6)	PD	2.0	٧V	
Thermal Desistance, lunction to Archient	(Note 5)	5	113		
Thermal Resistance, Junction to Ambient	(Note 6)	R _{θJA}	61	°C/W	
Thermal Resistance, Junction to Case	(Note 6)	R _{θJC}	6.6		
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to +150	°C	

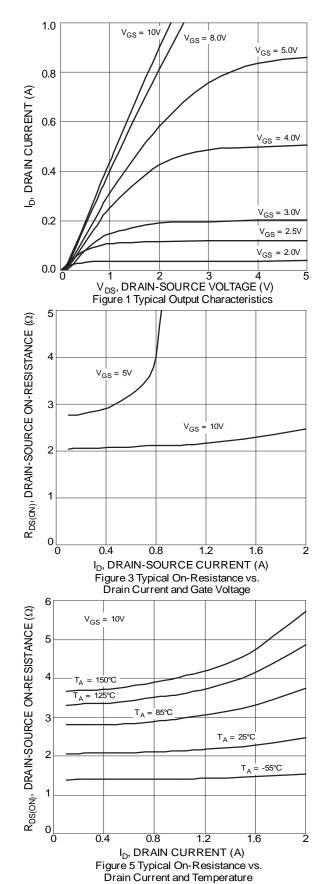
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

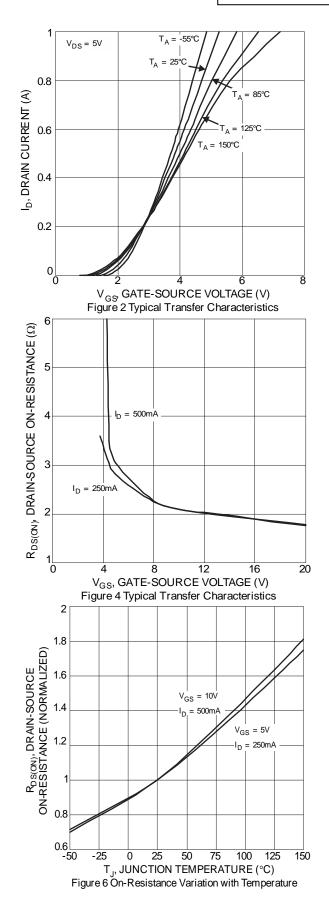
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	100	_	_	V	$V_{GS} = 0V, I_D = 1mA$	
Zero Gate Voltage Drain Current	IDSS			10 100	μA	$V_{DS} = 100V, V_{GS} = 0V$ $V_{DS} = 80V, V_{GS} = 0V, T_J = +125^{\circ}C$	
Gate-Body Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
On-State Drain Current	I _{D(ON)}	750	_	_	mA	$V_{DS} = 25V, V_{GS} = 5V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(TH)}	0.75	_	1.5	V	$V_{DS} = V_{GS}, I_D = 1mA$	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	_	3.0	Ω	$V_{GS} = 10V, I_D = 500mA$	
Static Drain-Source On-Resistance		_	_	4.5		$V_{GS} = 5.0V, I_D = 250mA$	
Forward Transconductance	g fs	225	_	_	mS	$V_{DS} = 25V, I_D = 500mA$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss		47	75			
Output Capacitance	Coss	_	23	25	pF	$V_{DS} = 25V, V_{GS} = 0V, f = 1.0MHz$	
Reverse Transfer Capacitance	C _{rss}	_	6	8			
Turn-On Delay Time	t _{D(ON)}	_	2	7		V _{DD} = 25V, V _{GS} = 10V,	
Turn-On Rise Time	t _R	_	3	12			
Turn-Off Delay Time	t _{D(OFF)}	_	5	15	ns	$R_{G} = 6.0\Omega, I_{D} = 1.0A$	
Turn-Off Fall Time	t _F	_	2	13			

 Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
 Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
 Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to product testing. Notes:



NEW PRODUCT

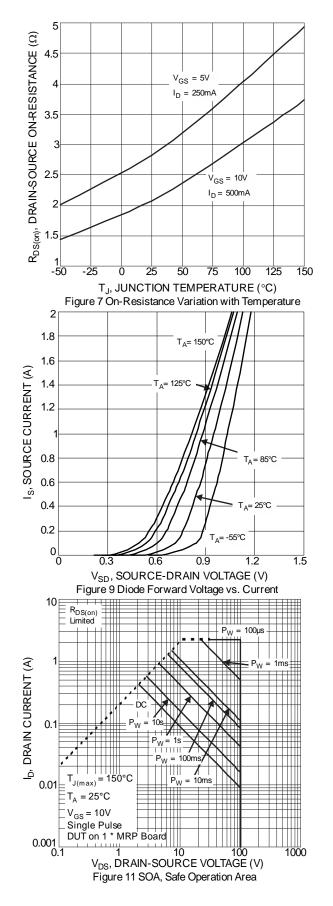


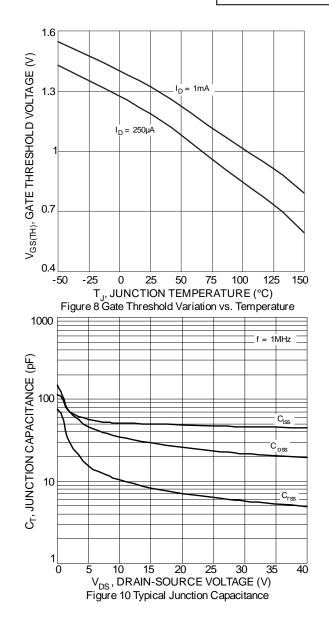


ZVNL110G Document number: DS33386 Rev. 4 - 2

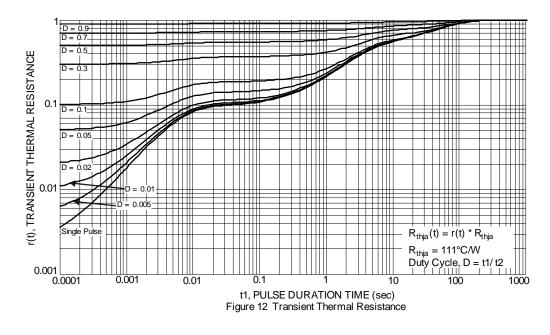


NEW PRODUCT



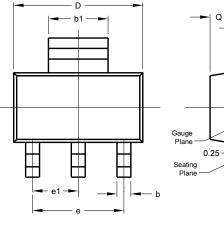


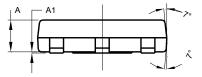


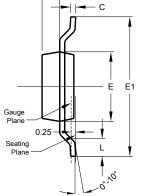


Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.





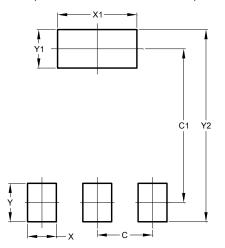


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SOT223					
Dim	Dim Min Max Typ				
Α	1.55	1.65	1.60		
A1	0.010	0.15	0.05		
b	0.60	0.80	0.70		
b1	2.90	3.10	3.00		
С	0.20	0.30	0.25		
D	6.45	6.55	6.50		
Е	3.45	3.55	3.50		
E1	6.90	7.10	7.00		
е	-	-	4.60		
e1	-	-	2.30		
L	0.85	1.05	0.95		
q	0.84	0.94	0.89		
All	All Dimensions in mm				



Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	2.30
C1	6.40
Х	1.20
X1	3.30
Y	1.60
Y1	1.60
C2	8.00

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